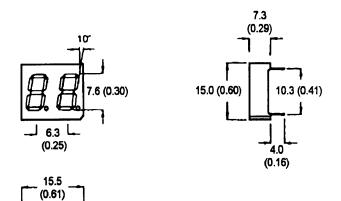


BRIGHT RED MSD318C, MSD319C GREEN MSD348C, MSD349C HIGH EFF. RED MSD398C, MSD399C

#### PACKAGE DIMENSIONS

Month & Bin



## FEATURES

Easy to read digits. 2 digit common anode or cathode. Low power consumption. Bold segments that are highly visible. High brightness with high contrast White segments on a grey face. Directly compatible with integrated circuits.

Rugged plastic/epoxy construction.

#### **APPLICATIONS**

Digital readout displays. Instrument panels.

NOTES: Dimensions are in mm (inch). All pins are 0.5 (0.02) diameter Tolerances are ± 0.25 (0.1) unless otherwise noted.

### **MODEL NUMBERS**

AN3XXC XXXX X

\_] 2.54 X 4 [\_ =10.16 (0.40)

Pin 1

Color Description Part number 2 Digit, Common Anode, RHDP. **Bright Red MSD318C** 2 Digit, Common Cathode, RHDP. MSD319C **Bright Red** 2 Digit, Common Anode, RHDP. MSD348C Green 2 Digit, Common Cathode, RHDP. MSD349C Green MSD398C High Eff. Red 2 Digit, Common Anode, RHDP. 2 Digit, Common Cathode, RHDP. MSD399C High Eff. Red (For other color options, contact your local area Sales Office)



**ABSOLUTE MAXIMUM RATING** (TA=25°C unless otherwise specified)

	B.Red	Green	High Eff. Red	
	MSD	MSD	MSD	
	318C	348C	398C	
Part number	319C	349C	399C	Unit
Continuous forward current (I <sub>f</sub> )				
Per Segment	15	25	25	mA
Peak forward current per die (I <sub>f</sub> ) (at f = 10.0 KHz, Duty factor = 1/10)	60	90	90	mA
Power dissipation (P <sub>D</sub> )	40*	70*	70*	mW
*Derate Linearly from 25°C	0.17	0.33	0.33	mW/°C
Reverse voltage per dice				5V
Operating and Storage temperature ra				
Lead soldering time (at 1/16 inch from the bottom of lamp)			5 seconds @ 230°C	

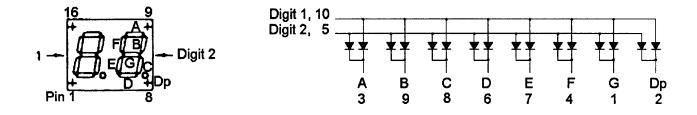
## **ELECTRO - OPTICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified)

	B. Red	Green	High Eff. Red	
	MSD	MSD	MSD	
	318C	348C	<b>398C</b>	Test
Part number	319C	349C	399C	Condition
Luminous intensity (ucd)				
minimum	210	540	800	l, = 20 mA
typical	650	1600	2200	l, = 20 mA
Forward voltage (V,)				
typical	2.1	2.1	2.0	l, = 20 mA
maximum	2.6	2.8	2.8	l, = 20 mA
Peak wavelength (nm)	697	570	635	l, = 20 mA
Spectral line half width (nm)	90	30	45	l, = 20 mA
Reverse breakdown voltage (V <sub>R</sub> )	5	5	5	l <sub>r</sub> =100 uA

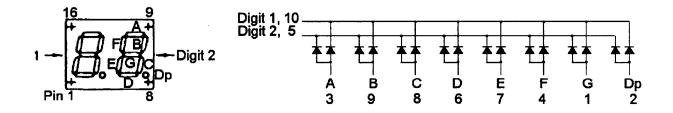


#### PINOUT

MSD3X8C - Common Anode

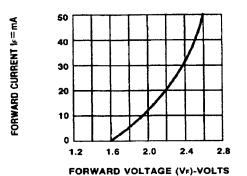


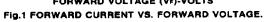
MSD3X9C - Common Cathode

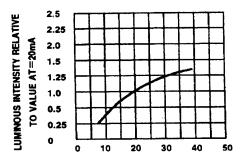




#### **GRAPHICAL DETAIL: Bright Red** ( $T_A = 25^{\circ}C$ unless otherwise specified)

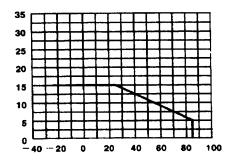




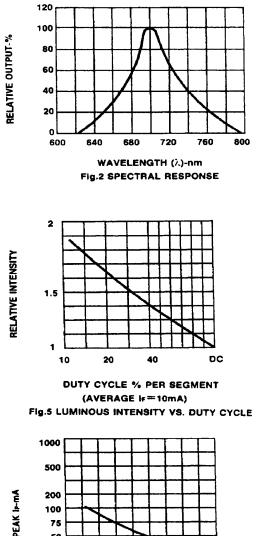


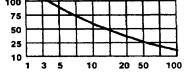
IF-FORWARD CURRENT-mA Fig.3 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT





TA AMBIENT TEMPERATURE C Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.

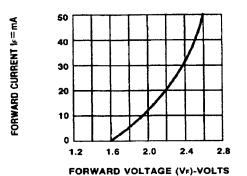


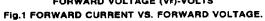


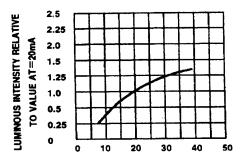
DUTY CYCLE % Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE % (REFRESH RATE 1=1 KHz)



#### **GRAPHICAL DETAIL: Bright Red** ( $T_A = 25^{\circ}C$ unless otherwise specified)

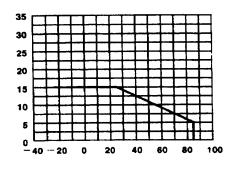




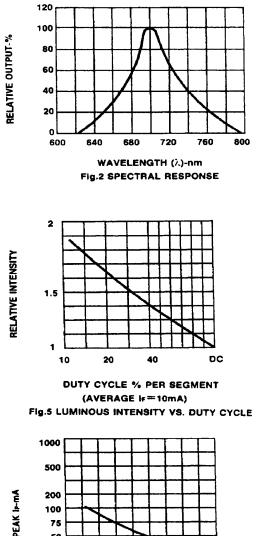


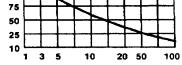
IF-FORWARD CURRENT-mA Fig.3 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT





TA AMBIENT TEMPERATURE C Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.





DUTY CYCLE % Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE % (REFRESH RATE 1=1 KHz)



**GRAPHICAL DETAIL: High Efficiency Red** ( $T_A = 25^{\circ}C$  unless otherwise specified)

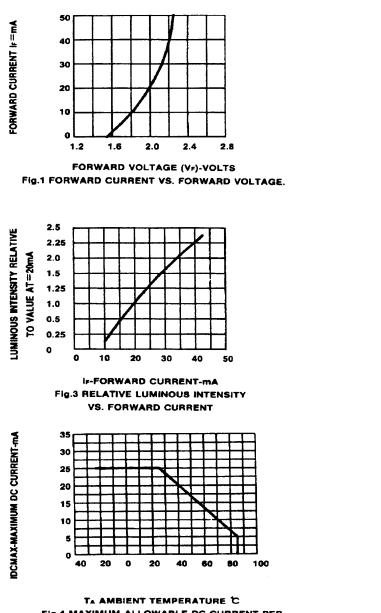
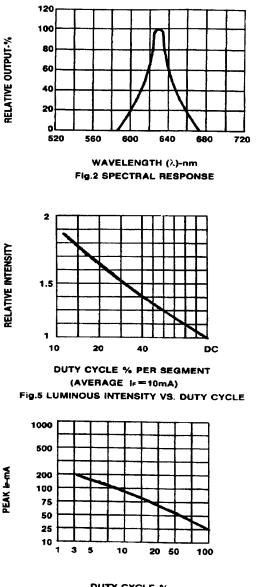


FIG.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.



DUTY CYCLE % Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE % (REFRESH RATE (=1 KHz)



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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.